			REVISIONS		
		REV.	DESCRIPTION	ECN NO.	DATE
Special Characteristic Symbols		Pre-01	FIRST RELEASE FOR RFQ#F2022-00853.		03/02/23
	SAFETY				
	CRITICAL				
\bigcirc	IMPORTANT				

In case of contradicting requirements the following priority is valid:

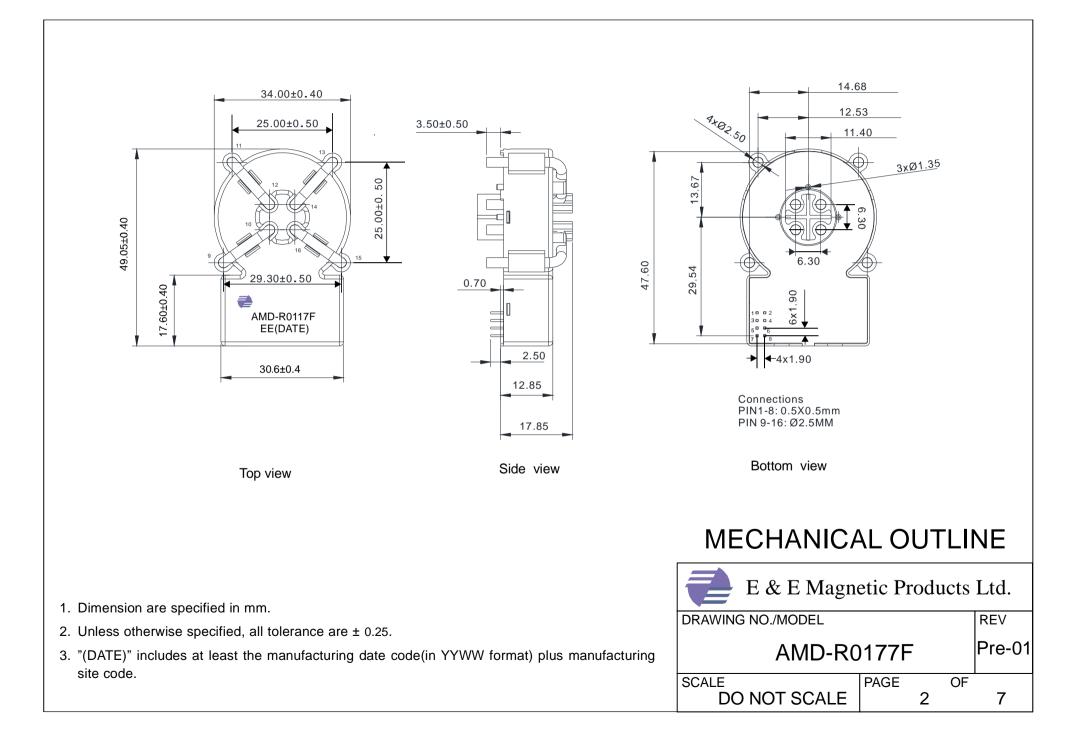
- legal requirements
- specification

- drawing

- other applicable documents

Automotive HALOGEN-FREE ELV TITLE Application AMOD, RCD, CURRENT SENSOR A35V00144F Lead free and RoHS compliant per EU Directive 2011/65/EU APPROVALS DATE UNLESS OTHERWISE E & E Magnetic Products Ltd. WARNING ! SPECIFIED, DIMENSIONS DRAWN BY ARE IN INCH/mm. K.DENG 03/02/23 DRAWING NO./MODEL REV PROJ. ENG ALL SHEETS OF THIS DOCUMENT ARE K.DENG 03/02/23 CONTROLLED DOCUMENTATION AND TOLERANCE ARE: AMD-R0117F ARE NOT TO BE RELEASED OUTSIDE Pre-01 J.YANG 03/02/23 INCH ANGLE mm OF E&E OR ITS SUB-CONTRACTORS .XXX ± .005 .XX ± .13 X.X ± 0.3 Q.A. WITHOUTAUTHORIZATION. W.ZHANG SCALE PAGE OF .XX ± .02 .X ± .5 X. ± 1 03/02/23 DO NOT SCALE 1 7

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4: FEATURES

- · PCB mounted RCD module
- \cdot Excellent accuracy
- \cdot Fluxgate current sensor with toroidal core
- · Switching open-collector outputs
- · Compact design

5: APPLICATIONS

Mainly used for stationary and mobile applications:

- · IC-CPD acc. to IEC62752
- · Compliance With IEC62955



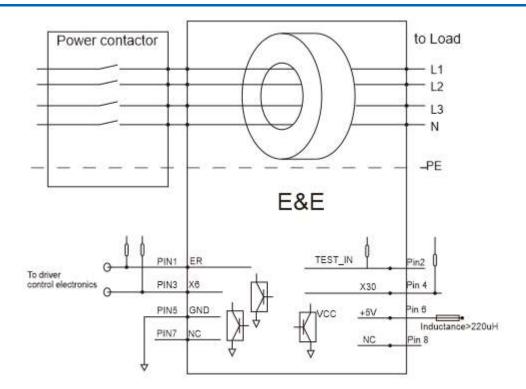
6: TYPICAL APPLICATION DIAGRAM:

General description of sensor function:

The Sensor is sensitive to AC and DC current and can be used for fault current detection in IC-CPD applications.

The Sensor detects AC and DC fault currents according to IEC62752:2016. In the event of a DC fault current, PIN 3 will change its state from a low level (GND) to high impedance state. In the event of an AC fault current, PINs 3 and 4 will change state from a low level (GND) to a high impedance state. Error conditions (e.g. an internal error) are signaled by PIN 1 (ERROR-OUT) which changes state to high impedance state.

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X6(PIN3)	X30(PIN4)	ER(PIN1)	State	
GND	GND	GND	Normal condition	
High Impedance	GND	GND	≥6mADC	
High Impedance	High Impedance	GND	≥30mArms	
High Impedance	High Impedance	High Impedance	ERROR	

PIN description:	
PIN no.	Description
PIN 1> ERROR-OUT (open collector output)	If no system fault is detected, the output PIN 1 is at low level (GND). If a system fault is detected, PIN is at high impedance state. In this case, PINs 3 and 4 will be set to a high impedance state too
PIN2>TEST_IN(refer to figure)	A function test is activated if this PIN is connected to GND Attention: During the functional test no differential current shall flow. If a push-pull switch is used, the voltage range must be 0V5V.
PIN 3> X6-OUT (open collector output)	If the residual current is below 6mA dc and no system fault occurs the output on PIN 3 is a low level (GND). In any other case output PIN 3 is in a high impedance state. If PIN 4 is high impedance, PIN 3 will also be set to high impedance.
PIN 4> X30-OUT (open collector output)	If the residual current is below the 30mA rms. and no system fault occur the output on PIN 4 is a low level (GND). In any other case PINs 3 and 4 are in a high impedance state.
PIN 5> GND	Ground connection
PIN 6> VCC	Positive supply voltage
PIN 7> N.C.	Not Connected
PIN 8> N.C.	Not Connected
PIN 9 PIN16	For primary wires connection

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Symbol	Parameter	Condition	min.	typ.	max.	Unit	remark
I _P	Primary rated current (1phase / 3phase)			32	40	А	
$I_{\Delta N,max}$	Measuring range (peak)		-300		300	mA	
f _{BW}	Frequency range		DC		2	kHz	
$I_{\Delta N1}$	Rated residual operating current 1		3.5	4.8	6	mA DC	
$I_{\Delta N2}$	Rated residual operating current 2		20	25	30 ⁽¹⁾ / 420 ⁽²⁾	mA RMS	(1)f = DC to 150Hz (2) f = 150Hz to 2kHz
		AC: In=1*I∆N2		150	300		
		AC: In=2*I∆N2		90	150		Interrupting Time according to IEC62752 (E)- 1:2016 Table 2 + 3
Tr	Response time	AC: In=5*I∆N2		25	40	– ms	
11		DC: In=1*I∆N1		300	10000		
		DC: In=10*I∆N1		90	300		
		DC: In=50*I∆N1		25 40			
$I_{\Delta R I 1}$	Hysteresis recovery current level for I∆N1 (absolute value dc)			2.5		mA	X6 will remain in their states until I∆ is below the recovery threshold I∆RI
I _{ARI2}	Hysteresis recovery current level for l∆N2 (absolute value rms)			10		mA	X30 will remain in their states until I∆ is below the recovery threshold I∆RI
V _{CC}	Supply voltage		4.8	5	5.2	V	
I _{CC}	Consumption current		TBD		TBD	mA	
T _A	Ambient operation temperature		-40		85	°C	

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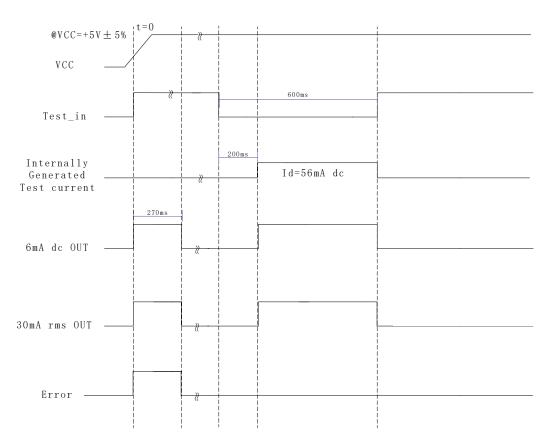
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Absolute maximum ratings

Symbol	Parameter	Condition	min.	typ.	max.	Unit	remark
V _{CE}	Collector-Emitter voltage (PINs 1, 3 and 4)				40	V	
I _C	Collector current (PINs 1, 3 and 4)				50	mA	
U _{MAX}	Maximum rated voltage of primary conductors				440	V	

Figure:

After activating the test sequence, the end product has to monitor the correct state of the outputs being used at the following points in time.



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